# 阅读申明

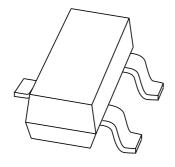
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#### **DISCRETE SEMICONDUCTORS**

# DATA SHEET



# PMBT5401 PNP high-voltage transistor

Product specification Supersedes data of 1999 Apr 15 2004 Jan 21





## PNP high-voltage transistor

#### **PMBT5401**

#### **FEATURES**

• Low current (max. 300 mA)

• High voltage (max. 150 V).

#### **APPLICATIONS**

• Switching and amplification in high voltage applications such as telephony.

#### **DESCRIPTION**

PNP high-voltage transistor in a SOT23 plastic package. NPN complement: PMBT5550.

#### **MARKING**

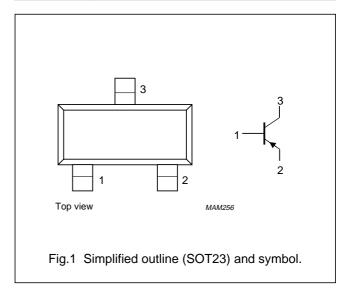
TYPE NUMBER	MARKING CODE(1)	
PMBT5401	*2L	

#### Note

\* = p : Made in Hong Kong.
 \* = t : Made in Malaysia.
 \* = W : Made in China.

#### **PINNING**

PIN	DESCRIPTION
1	base
2	emitter
3	collector



**ORDERING INFORMATION** 

TYPE	PACKAGE		
NUMBER	NAME	DESCRIPTION	VERSION
PMBT5401	_	plastic surface mounted package; 3 leads SOT23	

#### **LIMITING VALUES**

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V <sub>CBO</sub>	collector-base voltage	open emitter	_	-160	V
V <sub>CEO</sub>	collector-emitter voltage	open base	_	-150	V
V <sub>EBO</sub>	emitter-base voltage	open collector	_	-5	V
I <sub>C</sub>	collector current (DC)		_	-300	mA
I <sub>CM</sub>	peak collector current		_	-600	mA
I <sub>BM</sub>	peak base current		_	-100	mA
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> ≤ 25 °C; note 1	_	250	mW
T <sub>stg</sub>	storage temperature		-65	+150	°C
T <sub>j</sub>	junction temperature		_	150	°C
T <sub>amb</sub>	operating ambient temperature		-65	+150	°C

#### Note

1. Transistor mounted on an FR4 printed-circuit board.

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# PNP high-voltage transistor

PMBT5401

#### THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R <sub>th(j-a)</sub>	thermal resistance from junction to ambient	note 1	500	K/W

#### Note

1. Transistor mounted on an FR4 printed-circuit board.

#### **CHARACTERISTICS**

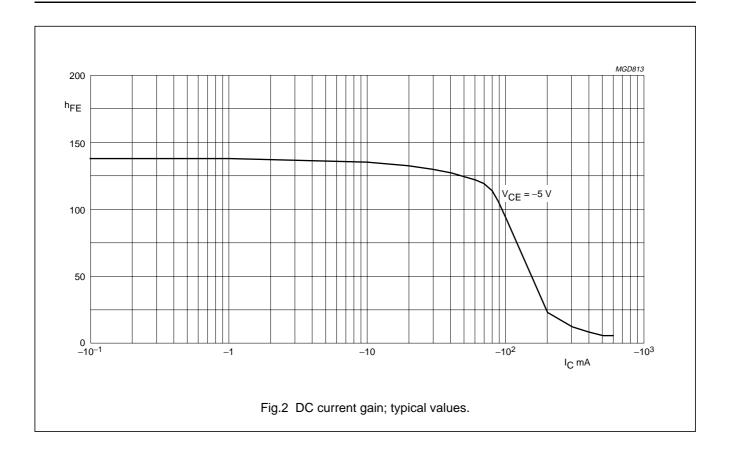
 $T_j = 25$  °C unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
I <sub>CBO</sub>	collector-base cut-off current	I <sub>E</sub> = 0; V <sub>CB</sub> = -120 V	_	-50	nA
		I <sub>E</sub> = 0; V <sub>CB</sub> = -120 V; T <sub>amb</sub> = 150 °C	_	-50	μΑ
I <sub>EBO</sub>	emitter-base cut-off current	$I_C = 0; V_{EB} = -4 V$	_	-50	nA
h <sub>FE</sub>	DC current gain	V <sub>CE</sub> = -5 V; (see Fig.2)			
		$I_C = -1 \text{ mA}$	50	_	
		$I_{C} = -10 \text{ mA}$	60	240	
		$I_{\rm C} = -50 \text{ mA}$	50	_	
V <sub>CEsat</sub>	collector-emitter saturation voltage	$I_C = -10 \text{ mA}; I_B = -1 \text{ mA}$	_	-200	mV
		$I_C = -50 \text{ mA}; I_B = -5 \text{ mA}$	_	-500	mV
V <sub>BEsat</sub>	base-emitter saturation voltage	$I_C = -10 \text{ mA}; I_B = -1 \text{ mA}$	_	-1	V
		$I_C = -50 \text{ mA}; I_B = -5 \text{ mA}$	_	-1	V
C <sub>c</sub>	collector capacitance	$I_E = I_e = 0$ ; $V_{CB} = -10 \text{ V}$ ; $f = 1 \text{ MHz}$	_	6	pF
f <sub>T</sub>	transition frequency	$I_C = -10 \text{ mA}; V_{CE} = -10 \text{ V};$ $f = 100 \text{ MHz}; T_{amb} = 25 ^{\circ}\text{C}$	100	300	MHz
F	noise figure	$I_C$ = -200 μA; $V_{CE}$ = -5 V; $R_S$ = 2 kΩ; $f$ = 10 Hz to 15.7 kHz; $T_{amb}$ = 25 °C	_	8	dB

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# PNP high-voltage transistor

## PMBT5401



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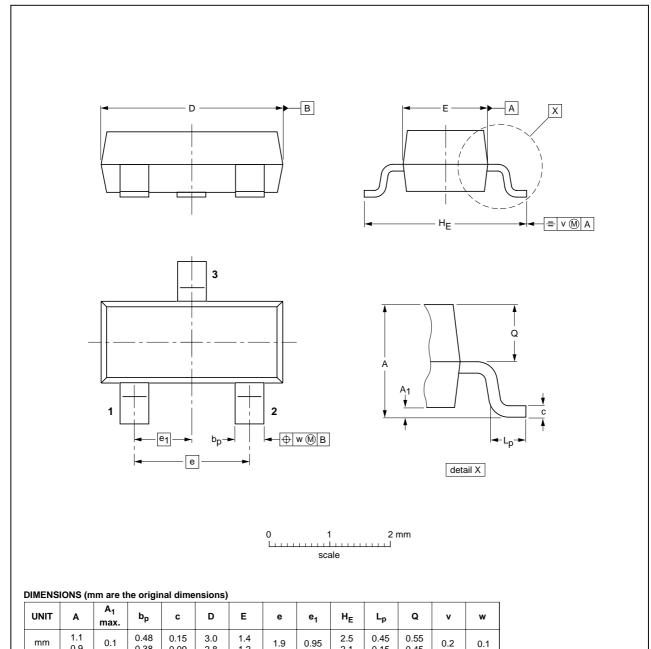
# PNP high-voltage transistor

PMBT5401

#### **PACKAGE OUTLINE**

#### Plastic surface mounted package; 3 leads

SOT23



OUTLINE	ITLINE REFERENCES			EUROPEAN	ISSUE DATE	
VERSION IE	EC JEDEC	EIAJ		PROJECTION	ISSUE DATE	
SOT23	TO-236AB				<del>97-02-28</del> 99-09-13	

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#### PNP high-voltage transistor

**PMBT5401** 

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LEVEL	DATA SHEET STATUS <sup>(1)</sup>	PRODUCT STATUS(2)(3)	DEFINITION
I	Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
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